





DUAL COMPLEMENTARY PRE-BIASED TRANSISTORS

Features

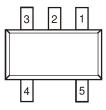
- Ultra-Small Surface Mount Package
- Epitaxial Planar Die Construction
- Surface Mount Package Suited for Automated Assembly
- Simplifies Circuit Design and Reduces Board Space
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (UMC4NQ)

Mechanical Data

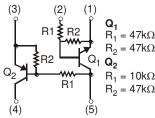
- Case: SOT353
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.006 grams (Approximate)











Device Schematic

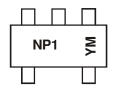
Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inch)	Tape Width (mm)	Quantity per Reel
UMC4N-7	AEC-Q101	NP1	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



NP1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Year	2017		2018	2019		2020	2021		2022	2023		2024
Code	Е		F	G		Н			J	K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings, Pre-Biased NPN Transistor, Q₁ (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	V _{CC}	50	V
Input Voltage	V _{IN}	-10 to +40	V
Output Current	I ₀	30	mA
Collector Current	Ic	100	mA

Absolute Maximum Ratings, Pre-Biased PNP Transistor, Q2 (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	V _{CC}	-50	V
Input Voltage	V _{IN}	-40 to +6	V
Output Current	I _O	-100	mA
Collector Current	Ic	-100	mA

Thermal Characteristics (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	150	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	833	°C/W
Operating and Storage Temperature Range	T_{J}, T_{STG}	-55 to +150	°C

Note:

Electrical Characteristics, Pre-Biased NPN Transistor, Q₁ (@T_A = +25°C unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	(Note 6)	$V_{I(OFF)}$	0.5	_	_	V	$V_{CC} = 5V$, $I_{O} = 100 \mu A$
Input Voltage	(Note 7)	$V_{I(ON)}$	_	_	3	V	$V_O = 0.3V, I_O = 2mA$
Output Voltage		V _{O(ON)}	_	0.1	0.3	V	$I_{O} / I_{I} = 10 \text{mA} / 0.5 \text{ mA}$
Input Current		lı	_	_	0.18	mA	$V_I = 5V$
Output Current		I _{O(OFF)}	_	_	0.5	μΑ	$V_{CC} = 50V, V_{I} = 0V$
DC Current Gain		Gı	68	_	_	_	$V_{O} = 5V, I_{O} = 5mA$
Gain-Bandwidth Product (Note 8)		f _T	_	250	_	MHz	$V_{CE} = 10V$, $I_{E} = -5mA$, $f = 100MHz$
Input Resistance		R ₁	32.9	47	61.1	kΩ	_
Resistance Ratio		R ₂ /R ₁	0.8	1	1.2	_	_

Notes:

- 6. The device is guaranteed to be in "OFF" state with $V_{I(OFF)}$ up to 0.5V.
- 7. The device is guaranteed to be in "ON" state with $V_{I(ON)}$ starting from 3V.
- 8. Characteristic of Transistor for reference only.

Electrical Characteristics, Pre-Biased PNP Transistor, Q2 (@TA = +25°C unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Innut Valtage	(Note 9)	$V_{I(OFF)}$	-0.3	_	_	V	$V_{CC} = -5V$, $I_{O} = -100\mu A$
Input Voltage	(Note 10)	V _{I(ON)}	_	_	-1.4	V	$V_O = -0.3V$, $I_O = -1mA$
Output Voltage		V _{O(ON)}		-0.1	-0.3	V	$I_{O}/I_{I} = -5mA/-0.25 \text{ mA}$
Input Current		lı	_	_	-0.88	mA	$V_I = -5V$
Output Current		I _{O(OFF)}	_	_	-0.5	μΑ	$V_{CC} = -50V$, $V_I = 0V$
DC Current Gain		G _l	68	_	_	_	$V_O = -5V, I_O = -5mA$
Gain-Bandwidth Product (Note 11)		f _T	_	250	_	MHz	$V_{CE} = -10V$, $I_{E} = 5mA$, $f = 100MHz$
Input Resistance		R ₁	7	10	13	kΩ	_
Resistance Ratio		R ₂ /R ₁	3.7	4.7	5.7	_	

Notes:

- 9. The device is guaranteed to be in "OFF" state with $V_{\text{I(OFF)}}\,\text{up}$ to -0.3V.
- 10. The device is guaranteed to be in "ON" state with $V_{I(ON)}$ starting from -1.4V.
- 11. Characteristic of Transistor for reference only.

^{5.} For the device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.



Typical Electrical Characteristics (@TA = +25°C unless otherwise specified.)

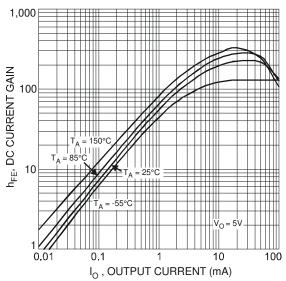
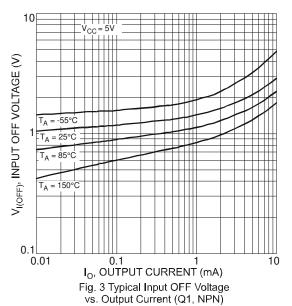


Fig. 1 Typical DC Current Gain vs. Output Current (Q1, NPN)



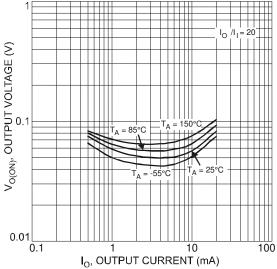
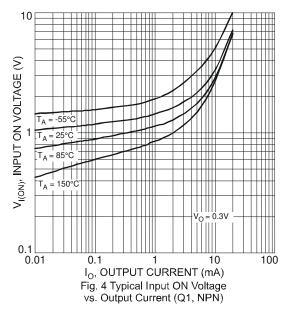
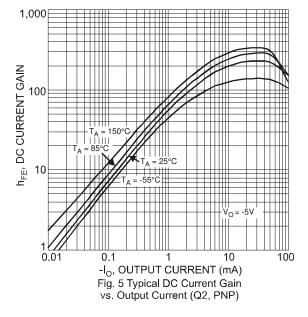


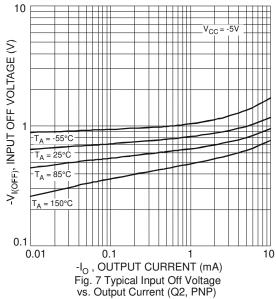
Fig. 2 Typical Output Voltage vs. Output Current (Q1, NPN)

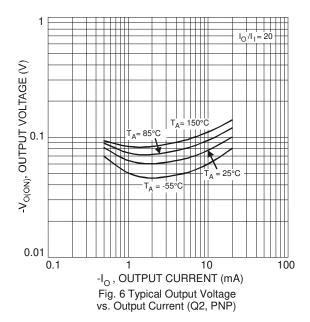


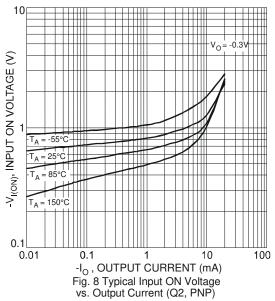


Typical Electrical Characteristics (Cont.) (@TA = +25°C unless otherwise specified.)







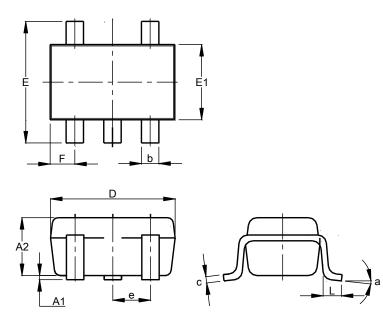




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT353

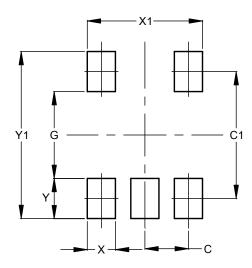


	SO	T353				
Dim	Min	Max	Тур			
A 1	0.00	0.10	0.05			
A2	0.90	1.00	1.00			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	C).650 B	SC			
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT353



Dimensione	Value
Dimensions	(in mm)
С	0.650
C1	1.900
G	1.300
Х	0.420
X1	1.720
Υ	0.600
V1	2 500



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2017, Diodes Incorporated

www.diodes.com